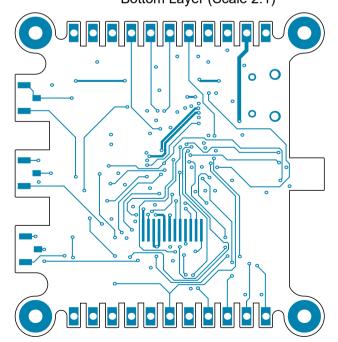
[1610mil]
40.9mm

Top Layer (Scale 2:1)

Bottom Layer (Scale 2:1)



- 1. Overall PCB Dimensions: 40.9mm x 42.8mm
- 2. Route to shape on board outline layer .GM8.
- 3. PCB material shall be FR-4 with min Tg of 140C
- 4. Copper density shall be 1oz/sq in on all layers
- 5. Gold ENIG finish on pads
- 6. LPI solder mask color: RED
- 7. Legend color WHITE
- 8. Minimum drill size: 10mil
- 9. Minimum trace spacing: 5mil
- 10. Minimum trace width: 5mil
- 11. See file with .extrep extension for gerber layer assignments
- 12. NC Drill file will have a .txt extension
- 13. 4-Layer stackup with nominal 62.5mil finished thickness +/- 10%
- 14. Alternate stackup/materials may be used with prior written permission
- 15. PCB shall be fully electrically tested

В С